

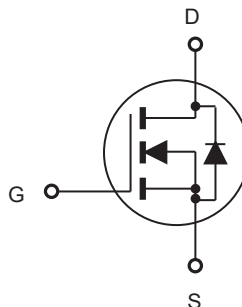


# CEP21N65SF/CEB21N65SF CEF21N65SF

## N-Channel Enhancement Mode Field Effect Transistor With Fast Body Diode

### FEATURES

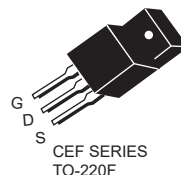
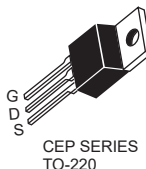
Type	$V_{DSS}@T_{Jmax}$	$R_{DS(ON)}$	$I_D$	@ $V_{GS}$
CEP21N65SF	700V	160m $\Omega$	21A	10V
CEB21N65SF	700V	160m $\Omega$	21A	10V
CEF21N65SF	700V	160m $\Omega$	21A <sup>d</sup>	10V



- Super high dense cell design for extremely low  $R_{DS(ON)}$ .
- High power and current handling capability.
- Pb-free lead plating ; RoHS compliant.
- Halogen Free.
- Fast reverse recovery time.

### APPLICATIONS

- Switch Mode Power Supply (SMPS).
- PWM Motor Controls.
- LED Lighting.
- Adapter.



### ABSOLUTE MAXIMUM RATINGS $T_C = 25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Limit		Units
		TO-220/263	TO-220F	
Drain-Source Voltage	$V_{DS}$	650		V
Gate-Source Voltage	$V_{GS}$	$\pm 30$		V
Drain Current-Continuous @ $T_C = 25^\circ\text{C}$ @ $T_C = 100^\circ\text{C}$	$I_D$	21	21 <sup>d</sup>	A
		13	13 <sup>d</sup>	A
Drain Current-Pulsed <sup>a</sup>	$I_{DM}^e$	84	84 <sup>d</sup>	A
Maximum Power Dissipation @ $T_C = 25^\circ\text{C}$ - Derate above $25^\circ\text{C}$	$P_D$	147	46	W
		1.17	0.36	W/ $^\circ\text{C}$
Single Pulsed Avalanche Energy <sup>g</sup>	$E_{AS}$	405		mJ
Single Pulsed Avalanche Current <sup>g</sup>	$I_{AS}$	9		A
Operating and Store Temperature Range	$T_J, T_{stg}$	-55 to 150		$^\circ\text{C}$

### Thermal Characteristics

Parameter	Symbol	Limit		Units
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	0.85	2.7	$^\circ\text{C}/\text{W}$
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	62.5	65	$^\circ\text{C}/\text{W}$



# CEP21N65SF/CEB21N65SF CEF21N65SF

## Electrical Characteristics $T_C = 25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Test Condition	Min	Typ	Max	Units
<b>Off Characteristics</b>						
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	650			V
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = 650V, V_{GS} = 0V$			10	$\mu A$
Gate Body Leakage Current, Forward	$I_{GSSF}$	$V_{GS} = 30V, V_{DS} = 0V$			100	nA
Gate Body Leakage Current, Reverse	$I_{GSSR}$	$V_{GS} = -30V, V_{DS} = 0V$			-100	nA
<b>On Characteristics<sup>b</sup></b>						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{GS} = V_{DS}, I_D = 250\mu A$	2.5		4.5	V
Static Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS} = 10V, I_D = 9.5A$		131	160	m $\Omega$
Gate input resistance	$R_g$	f=1MHz, open Drain		4.8		$\Omega$
<b>Dynamic Characteristics<sup>c</sup></b>						
Input Capacitance	$C_{iss}$	$V_{DS} = 200V, V_{GS} = 0V,$ $f = 1MHz$		1555		pF
Output Capacitance	$C_{oss}$			70		pF
Reverse Transfer Capacitance	$C_{rss}$			15		pF
<b>Switching Characteristics<sup>c</sup></b>						
Turn-On Delay Time	$t_{d(on)}$	$V_{DD} = 325V, I_D = 19A,$ $V_{GS} = 10V, R_{GEN} = 10\Omega$		33		ns
Turn-On Rise Time	$t_r$			9		ns
Turn-Off Delay Time	$t_{d(off)}$			61		ns
Turn-Off Fall Time	$t_f$			7		ns
Total Gate Charge	$Q_g$	$V_{DS} = 520V, I_D = 19A,$ $V_{GS} = 10V$		29		nC
Gate-Source Charge	$Q_{gs}$			7		nC
Gate-Drain Charge	$Q_{gd}$			12		nC
<b>Drain-Source Diode Characteristics and Maximum Ratings</b>						
Drain-Source Diode Forward Current	$I_S^f$				21	A
Drain-Source Diode Forward Voltage <sup>b</sup>	$V_{SD}$	$V_{GS} = 0V, I_S = 19A$			1.4	V
Reverse Recovery Time	$T_{rr}$	$I_F = 19A, di/dt = 100A/us$		165		ns
Reverse Recovery Charge	$Q_{rr}$			976		nC
<b>Notes :</b> a.Repetitive Rating : Pulse width limited by maximum junction temperature . b.Pulse Test : Pulse Width $\leq 300\mu s$ , Duty Cycle $\leq 2\%$ . c.Guaranteed by design, not subject to production testing. d.Limited only by maximum temperature allowed . e.Pulse width limited by safe operating area . f.Full package $I_{S(max)} = 11.7A$ . g.L = 10mH, $I_{AS} = 9A, V_{DD} = 100V, R_G = 25\Omega$ , Starting $T_J = 25^\circ C$ .						



# CEP21N65SF/CEB21N65SF CEF21N65SF

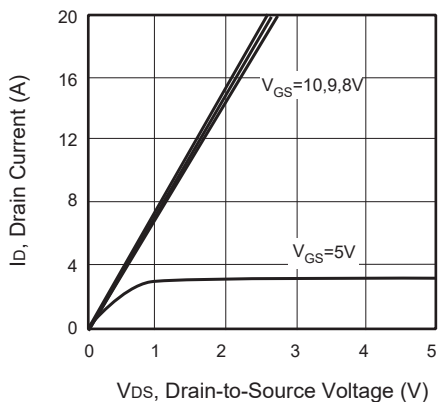


Figure 1. Output Characteristics

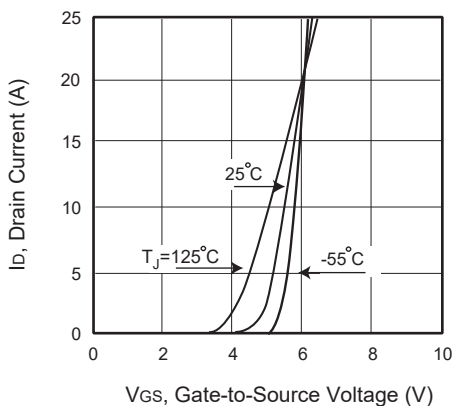


Figure 2. Transfer Characteristics

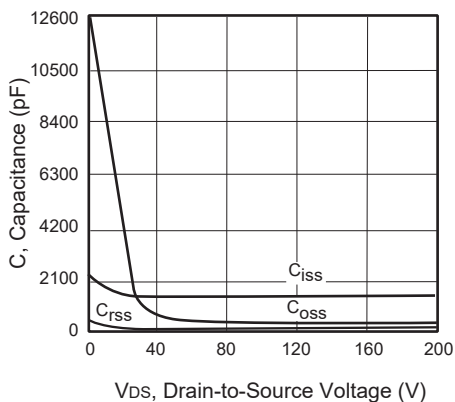


Figure 3. Capacitance

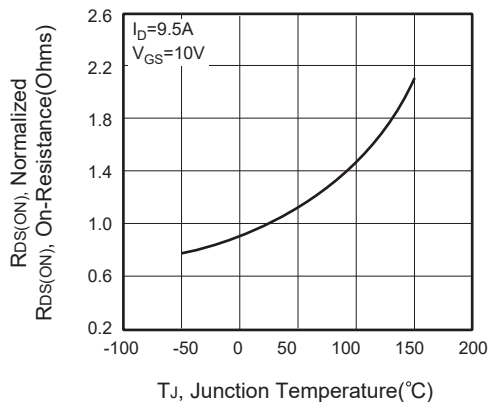


Figure 4. On-Resistance Variation with Temperature

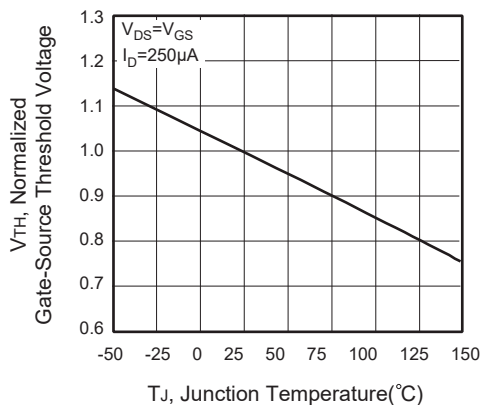


Figure 5. Gate Threshold Variation with Temperature

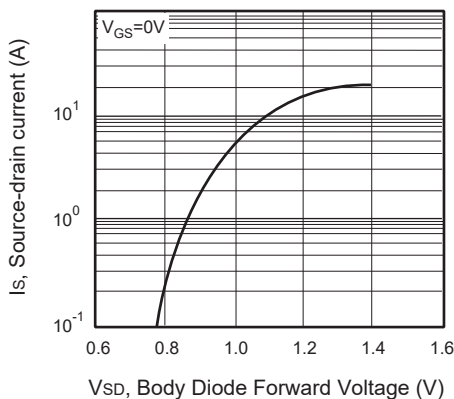


Figure 6. Body Diode Forward Voltage Variation with Source Current

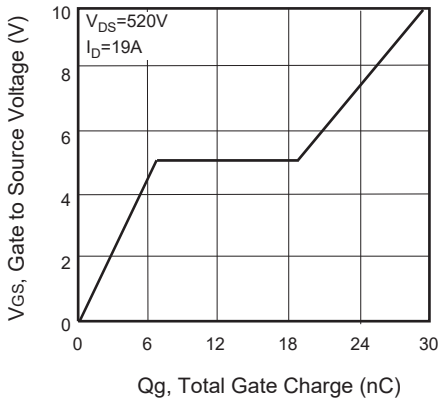


Figure 7. Gate Charge

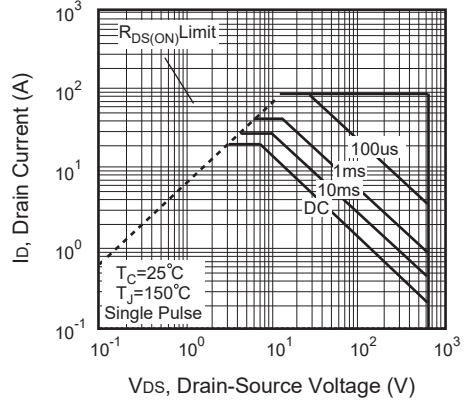


Figure 8. Maximum Safe Operating Area

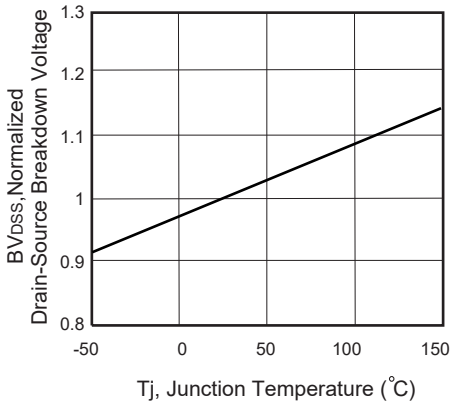


Figure 9. Breakdown Voltage Variation VS Temperature

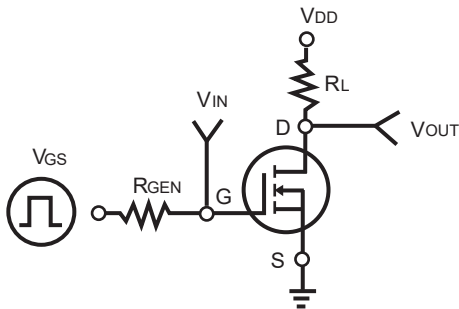


Figure 10. Switching Test Circuit

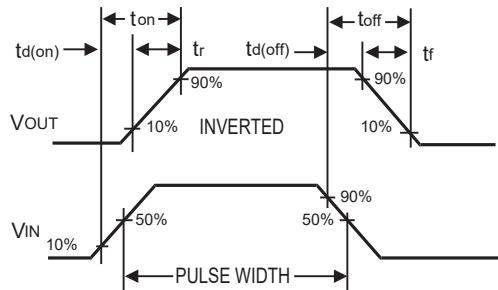


Figure 11. Switching Waveforms



# CEP21N65SF/CEB21N65SF CEF21N65SF

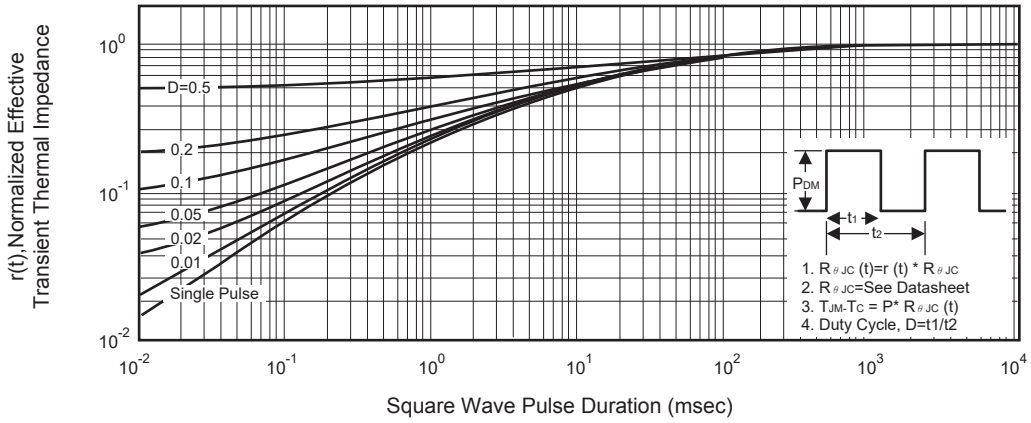


Figure 12. Normalized Thermal Transient Impedance Curve